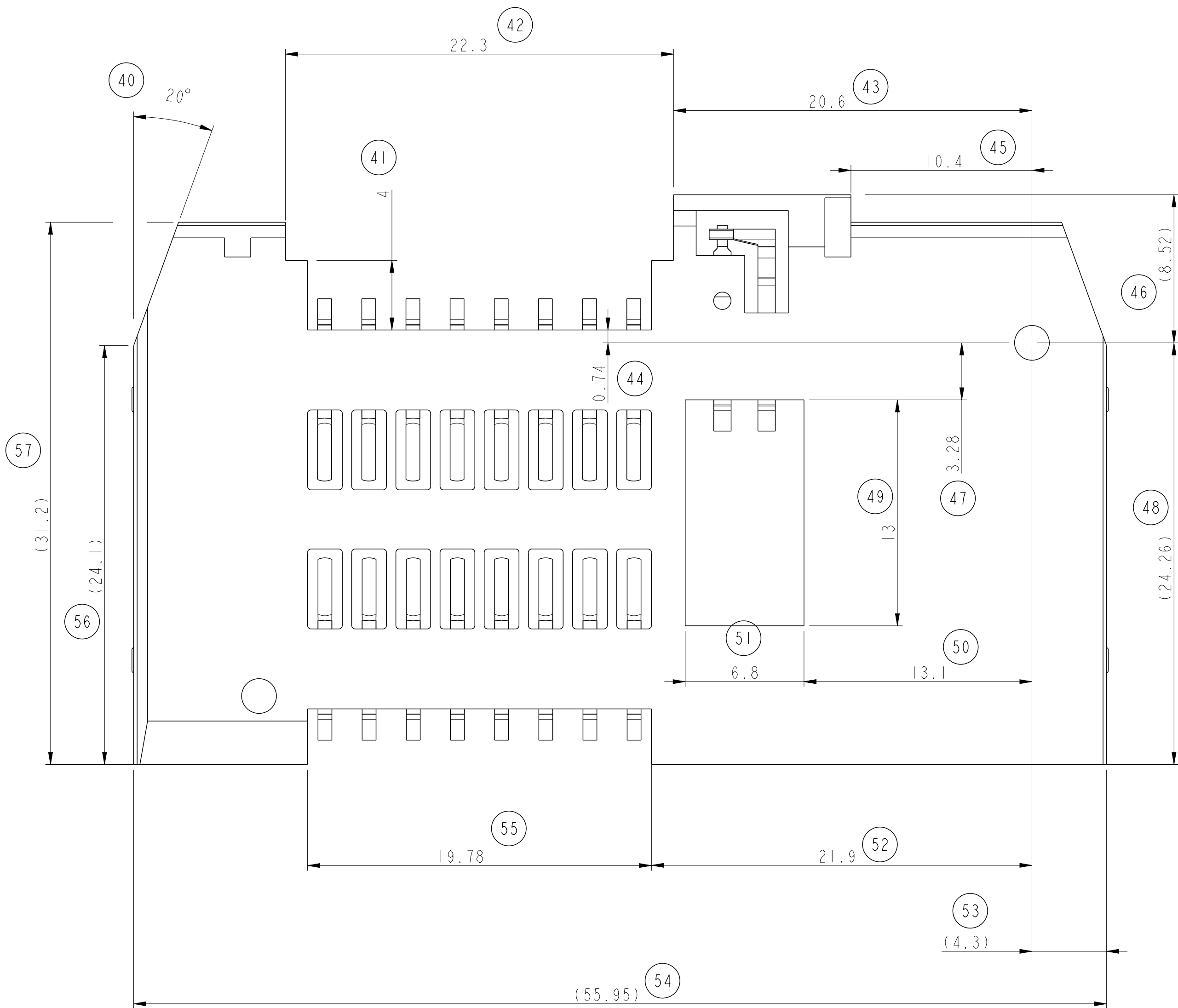
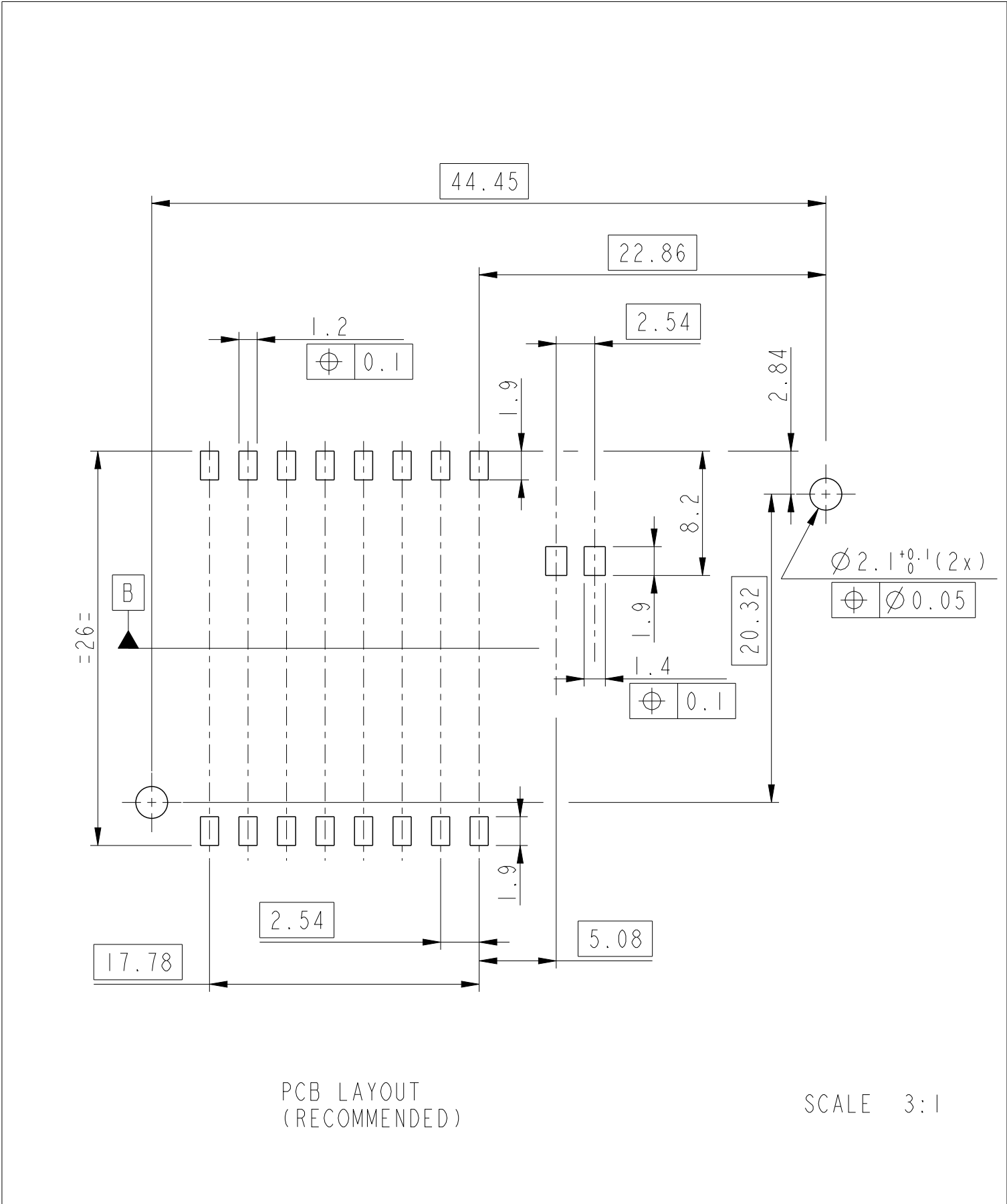




LEAD FREE CATALOGUE NUMBER
7312P0035A13LF



LAYOUT FOR KEEP OUT ZONE
(CONNECTOR SIDE)



NOTE: RoHS INFORMATIONS

- The "LF" products meet European Union Directives and other country regulations as described in GS-22-008.
- The housing will withstand exposure to 260°C peak temperature for 30 seconds in a convection, infra-red or vapor reflow oven. See Application notes/procedures, if they are available.
- Packaging spec: see GS-14-920

www.fciconnect.com			surface -- ✓		tolerance std		projection		mm 			
			ISO 1302		ISO 406 ISO 1101							
			TOLERANCES UNLESS OTHERWISE SPECIFIED									
Dr	PERNET	96/08/23	ANGULAR	LINEAR	0.X ±0.3		size A2	Scale 5:1				
Eng	GAMACHO	96/08/23			0.XX ±0.1							
Chr	CAILLER	96/08/23	0° ±2°		0.XXX ±0.05		ECN		109-0239			
Appr	GAMACHO	96/08/23	Product family MOBILE I/O				Spec ref		--			
			title CHIP CARD CONNECTOR				dwg no	VJW53663			Rev. F	
			TYPE : P00 (16 cts without cover)									
			catalog no 7312P0035A13				CUSTOMER			sheet 2 of 2		